# MSKSEMI















**ESD** 

TVS

TSS

MOV

**GDT** 

**PLED** 

# Brodnet data speet

www.msksemi.com



80W peak pulse power per line ( $t_P = 8/20\mu s$ )

SOD-923 package

Replacement for MLV(0402)

Bidirectional configurations

Response time is typically < 1ns

Low clamping voltage

RoHS compliant

Transient protection for data lines to

EC61000-4-2(ESD) ±30KV(air), ±30KV(contact);

IEC61000-4-4 (EFT) 40A (5/50ns)



Cellular phones

Portable devices

Digital cameras

Power supplies



Lead finish:100% matte Sn(Tin)

Mounting position: Any

Qualified max reflow temperature:260 ℃

Device meets MSL 1 requirements

Pure tin plating: 7 ~ 17 um

Pin flatness:≤3mil

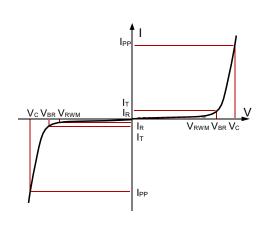


SOD-923



#### **Electronics Parameter**

Symbol	Parameter		
$V_{RWM}$	Peak Reverse Working Voltage		
I <sub>R</sub>	Reverse Leakage Current @ V <sub>RWM</sub>		
$V_{BR}$	Breakdown Voltage @ I⊤		
Ι <sub>Τ</sub>	Test Current		
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current		
Vc	Clamping Voltage @ I <sub>PP</sub>		
$P_PP$	Peak Pulse Power		
СJ	Junction Capacitance		
I <sub>F</sub>	Forward Current		
$V_{F}$	Forward Voltage @ I <sub>F</sub>		





## Electrical characteristics per line@25℃ (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Peak Reverse Working Voltage	$V_{RWM}$				5	٧
Breakdown Voltage	$V_{BR}$	I <sub>t</sub> = 1mA	5.6	6.7	7.8	٧
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V T=25℃			1.0	μA
Maximum Reverse Peak Pulse Current	I <sub>PP</sub>			5		Α
Clamping Voltage	Vc	I <sub>PP</sub> =1A			8	٧
Clamping Voltage	Vc	I <sub>PP</sub> =3A			13	٧
Clamping Voltage	Vc	I <sub>PP</sub> =5A			15	V
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> =0V f = 1MHz		12	15	pF

#### Absolute maximum rating@25℃

Rating	Symbol	Value	Units
Peak Pulse Power (t <sub>p</sub> =8/20μs)	P <sub>pp</sub>	80	W
Operating Temperature	TJ	-55 to +150	$^{\circ}$ C
Storage Temperature	T <sub>STG</sub>	-55 to +150	$^{\circ}$

#### **Typical Characteristics**



Fig 1.Pulse Waveform

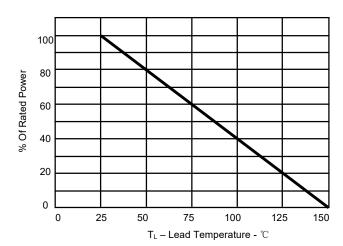


Fig 2.Power Derating Curve

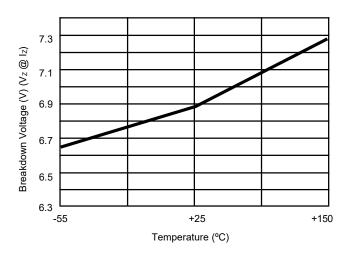


Fig 3.Typical Breakdown Voltage vs. Temperature

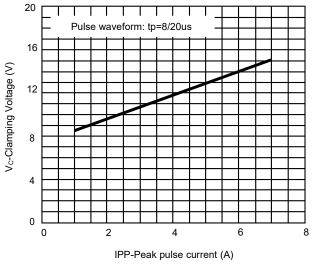


Fig 5. Clamping voltage vs. Peak pulse current

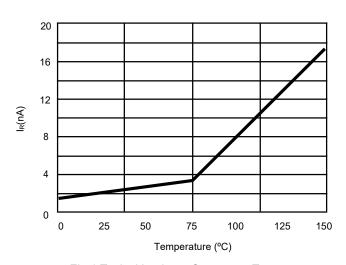


Fig 4. Typical Leakage Current vs. Temperature

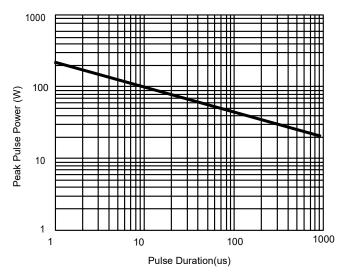
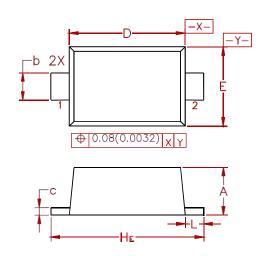


Fig 6. Non-Repetitive Peak Pulse Power vs. Pulse time

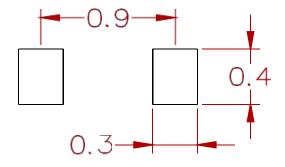


#### **PACKAGE MECHANICAL DATA**



Dim	Millimeters			Inches			
	Min	Nom	Max	Min	Nom	Max	
Α	0.36	0.40	0.43	0.014	0.016	0.017	
b	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.07	0.12	0.17	0.003	0.005	0.007	
D	0.75	0.80	0.85	0.030	0.031	0.033	
Е	0.55	0.60	0.65	0.022	0.024	0.026	
HE	0.95	1.00	1.05	0.037	0.039	0.041	
L	0.05	0.10	0.15	0.002	0.004	0.006	

#### **Suggested Pad Layout**



**Dimensions: Millimeters** 

#### **REEL SPECIFICATION**

5.01	DIVO	0.777
P/N	PKG	QTY
ESD9B5.0ST5G	SOD-923	8000



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